



Ó

Ο

 \mathbf{O}

Ő



0

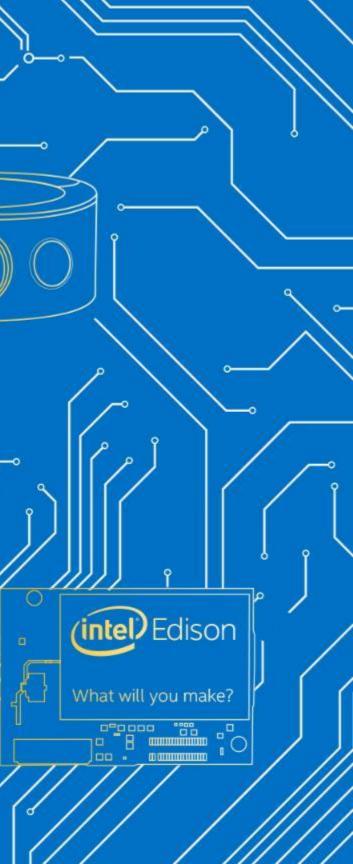
Malmö

The Next Revolution in Computing

Lowering barriers to entry to IOT and wearable with Intel Edison™

Yorick Schetgen

IOT and Wearable products & Solutions Intel EMEA



Making Everything Smart



ROBOTICS



MEDICAL IMAGING



NETWORK APPLIANCES



IP CAMERAS



ENERGY & UTILITIES CONTROL





HOME AUTOMATION



TRANSPORTATION



MEDICAL IMAGING



POINT OF SALE



MEDICAL DEVICE



PRINTER



ROUTING & SWITCHING



KIOSK



WIRELESS INFRASTRUCTURE



DIGITAL SIGNAGE



MANUFACTURING





TRANSPORTATION



MILITARY













IN-VEHICLE INFOTAINMENT

Intel Confidential







INDUSTRIAL PC



THE BIG OPPORTUNITY

CONNECTED DEVICES GROWING AT 300%³

DATA GROWING AT 2X PER YEAR

DATA GROWTH BY 2016 – 90% UNSTRUCTURED² **15B** Devices 2015

2B

Devices 2006

¹IDC, Intel, United Nations ²IDC Digital Universe Study, December 2012 3- McKinsey Global Institute

50B

Devices 2020¹

INTEL CONFIDENTIAL

Predictable Silicon Track Record Executing to **MOORE's LAW**

Enabling new devices with higher functionality and complexity while controlling power, cost, and size











45 nm 2007

INTEL CONFIDENTIAL









CALLING ALL INVENTORS ENTREPRENEURS AND DREAMERS

makers are going pro mimo

sparkfun



Tinkering with consumer electronics has **become mainstream**

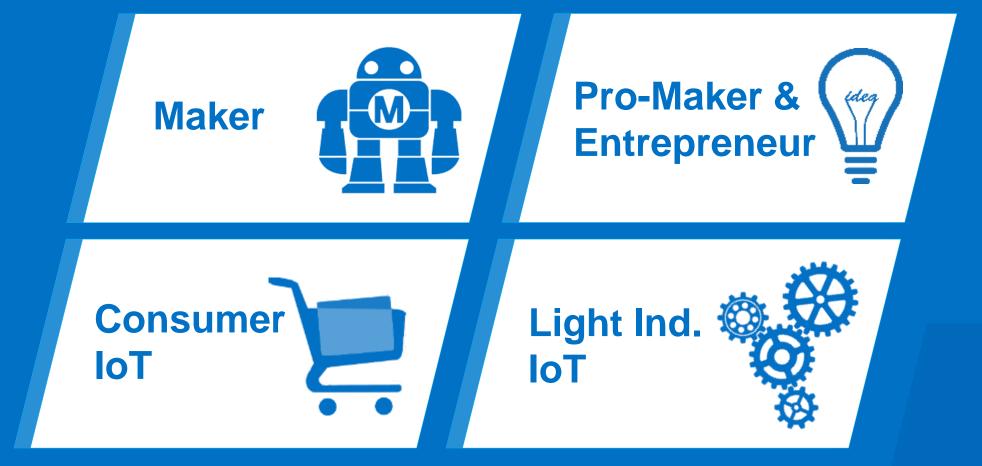


* Other names and brands may be claimed as the property of others.

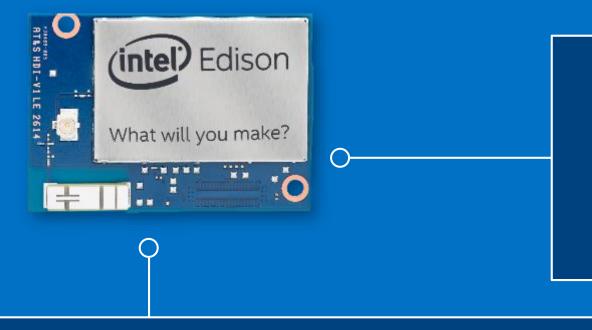
Not surprisingly, some



CALLING ALL INVENTORS ENTREPRENEURS AND DREAMERS

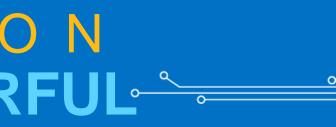


INTEL EDISON SMALL AND POWERFUL











INTEL EDISON

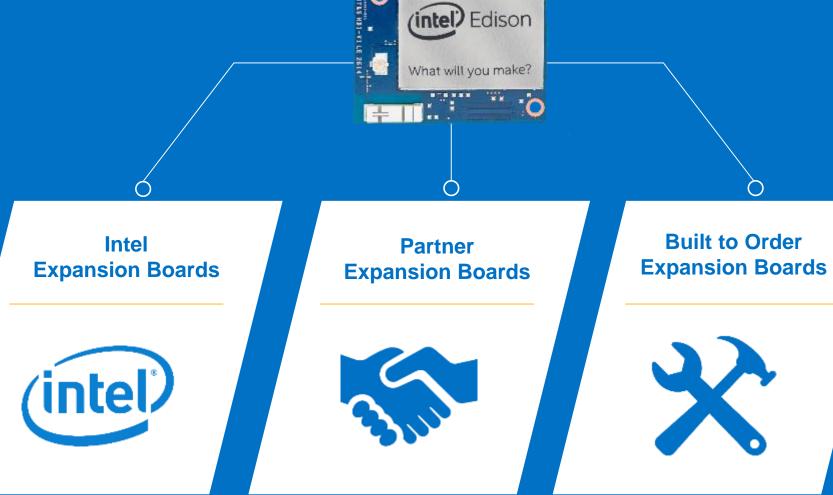
Expansio n Boards Broad Software Support Connecting To The Cloud

10101110101011101110010101010100100

Community Based Support

111010

EXPANSION BOARDS

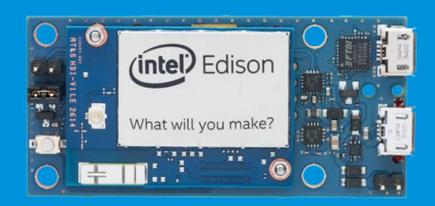


INTEL EXPANSION BOARDS

Arduino Board



Mini Breakout Board









PARTNER EXPANSION BOARDS

Sparkfun. **14 Sparkfun Blocks**



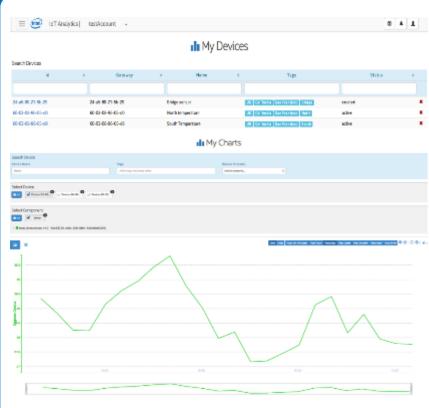


* Other names and brands may be claimed as the property of others.



CONNECTING IT ALL WITH THE CLOUD 0 4 1 So () (intel) Edison What will you make? + 11

http://software.intel.com/iot





FROM CONCEPT TO REAL APPLICATIONS



3DR

Internal Development

40 UNIQUE 10 COUNTRIES PROJECTS 10 WORLDWIDE 70 EDISON BETA UNITS - 80 MAKERS

External Development Partners





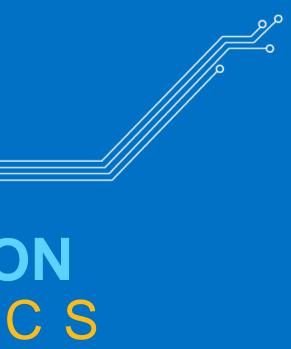


* Other names and brands may be claimed as the property of others.



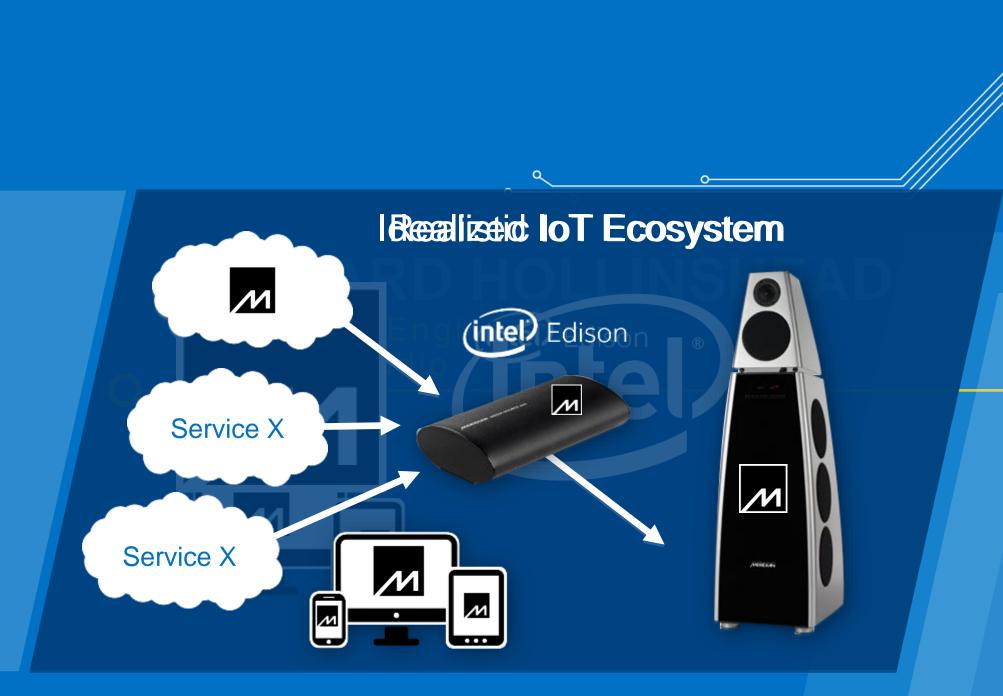


CHRIS ANDERSON 3 D R O B O T I C S





REDEFINE THE POSSIBLE MERIDIAN DSP LOUDSPEAKERS





* Other names and brands may be claimed as the property of others.



BRAILLE PRINTER

C









WHAT WILL YOU MAKE? Join the Edison community on maker.intel.com

Intel Makers: What Will You Make?





Community and Support

A community where Makers can come together to solve problems, share knowledge, and gain inspiration.

Join the conversation >

Intel® Edison fuels the next wave of small computing robotics to wearables

The Intel[®] Edison development platform is so small that it is going to make a huge impact on the Internet of Things and the world of wearables.

Discover Intel® Edison >





Ó

Ο

 \mathbf{O}

O



0

Malmö

Legal Disclaimer

INFORMATION IN THIS DOCUMENT IS PROVIDED IN CONNECTION WITH INTEL PRODUCTS. NO LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE, TO ANY INTELLECTUAL PROPERTY RIGHTS IS GRANTED BY THIS DOCUMENT. EXCEPT AS PROVIDED IN INTEL'S TERMS AND CONDITIONS OF SALE FOR SUCH PRODUCTS, INTEL ASSUMES NO LIABILITY WHATSOEVER AND INTEL DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY, RELATING TO SALE AND/OR USE OF INTEL PRODUCTS INCLUDING LIABILITY OR WARRANTIES RELATING TO FITNESS FOR A PARTICULAR PURPOSE, MERCHANTABILITY, OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT. A "Mission Critical Application" is any application in which failure of the Intel Product could result, directly or indirectly, in personal injury or death. SHOULD YOU PURCHASE OR USE INTEL'S PRODUCTS FOR ANY SUCH MISSION CRITICAL APPLICATION, YOU SHALL INDEMNIFY AND HOLD INTEL AND ITS SUBSIDIARIES, SUBCONTRACTORS AND AFFILIATES, AND THE DIRECTORS, OFFICERS, AND EMPLOYEES OF EACH, HARMLESS AGAINST ALL CLAIMS COSTS, DAMAGES, AND EXPENSES AND REASONABLE ATTORNEYS' FEES ARISING OUT OF, DIRECTLY OR INDIRECTLY, ANY CLAIM OF PRODUCT LIABILITY, PERSONAL INJURY, OR DEATH ARISING IN ANY WAY OUT OF SUCH MISSION CRITICAL APPLICATION, WHETHER OR NOT INTEL OR ITS SUBCONTRACTOR WAS NEGLIGENT IN THE DESIGN, MANUFACTURE, OR WARNING OF THE INTEL PRODUCT OR ANY OF ITS PARTS. Intel may make changes to specifications and product descriptions at any time, without notice. Designers must not rely on the absence or characteristics of any features or instructions marked "reserved" or "undefined". Intel reserves these for future definition and shall have no responsibility whatsoever for conflicts or incompatibilities arising from future changes to them. The information here is subject to change without notice. Do not finalize a design with this information. The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request. Contact your local Intel sales office or your distributor to obtain the latest specifications and before placing your product order. Copies of documents which have an order number and are referenced in this document, or other Intel literature, may be obtained by calling 1-800-548-4725, or go

to: http://www.intel.com/design/literature.htm

Code names featured are used internally within Intel to identify products that are in development and not yet publicly announced for release. Customers, licensees and other third parties are not authorized by Intel to use code names in advertising, promotion or marketing of any product or services and any such use of Intel's internal code names is at the sole risk of the user.

Intel, the Intel logo are trademarks of Intel Corporation in the United States and other countries.

Other names and brands may be claimed as the property of others. Copyright ©2014 Intel Corporation.